



1.MATERIAL

HOUSING:HTN UL 94V-0 OR LCP

CONTACT:PHOSPHOR BRONZE

SOLDER PAD:PHOSPHOR BRONZE

2.PLATING: TIN OVER NICKEL

3.SPECIFICATION

CURRENT RATING:1A AC,DC

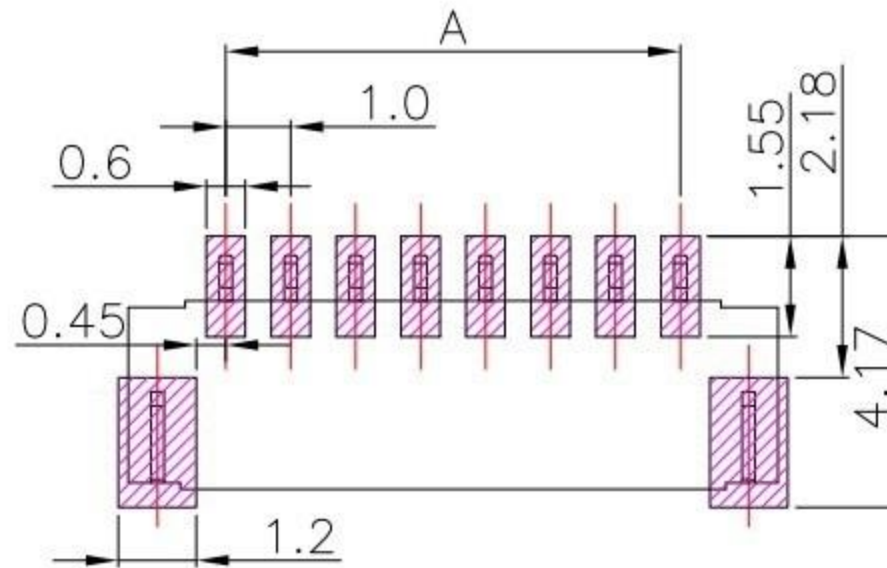
VOLTAGE RATING:250V AC,DC

TEMPERATURE RANGE:-25C~+85C

CONTACT RESISTANCE:20M MAX.

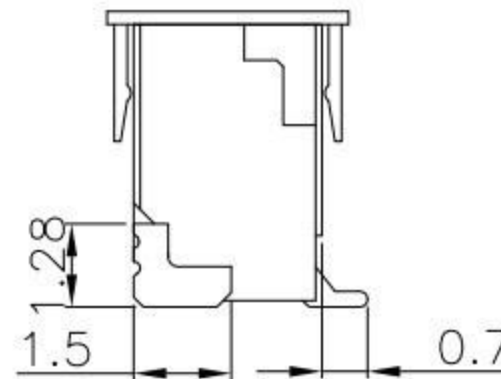
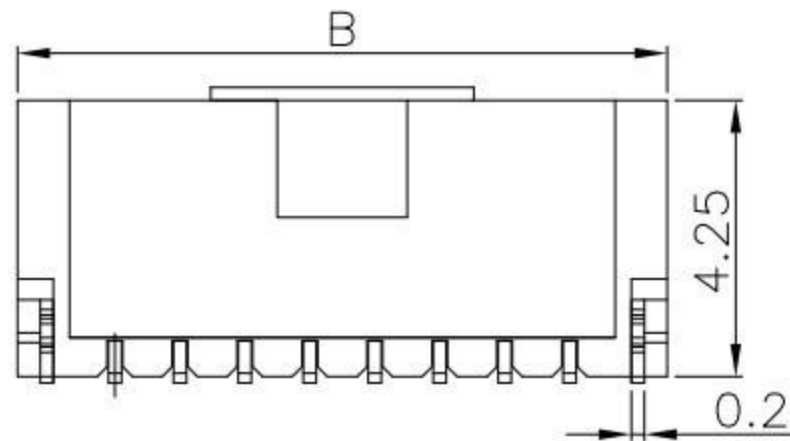
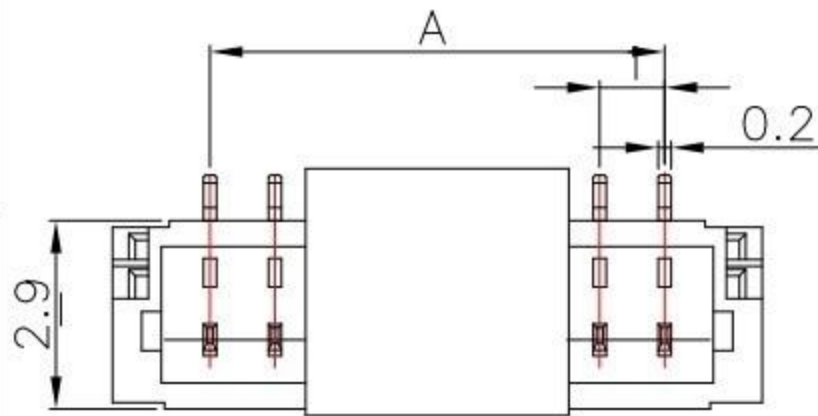
INSULATION RESISTANCE:1000M MIN.

WITHSTANDING VOLTAGE:500V AC/MINUTE



P.C.B LAYOUT MOUNTING PATTERN

PIN NO.	DIMENSION	
	A	B
02	1.00	4.00
03	2.00	5.00
04	3.00	6.00
05	4.00	7.00
06	5.00	8.00
07	6.00	9.00
08	7.00	10.00
09	8.00	11.00
10	9.00	12.00
11	10.00	13.00
12	11.00	14.00
13	12.00	15.00
14	13.00	16.00
15	14.00	17.00
16	15.00	18.00
17	16.00	19.00
18	17.00	20.00
19	18.00	21.00
20	19.00	22.00



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TOLERANCE UNLESS OTHERWISE STATED:

Up to 5 ±0.2
Above 5 - 15 ±0.3
Above 15 - 30 ±0.4
Above 30 - 50 ±0.5
Angle ±0.3

3RD. ANGEL'S



UNITS

MM

DRAWN BY: DATE

Jack Lu 10/15/15

CHECKED BY: DATE

Jacky Chen 10/15/15

APPROVED BY: DATE

Tony Kao 10/15/15

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	WAFER 1.0 SMT 180度(JST)
SCALE	1 : 1	DWG NO.	
SHEET NO.	1 of 1	PART NO.	
		SIZE	A4
		VER	R1

ITEM NO	DESCRIPTION	DRAWN	DATE
1	更新B尺寸標示位置	Jack	10/15/15